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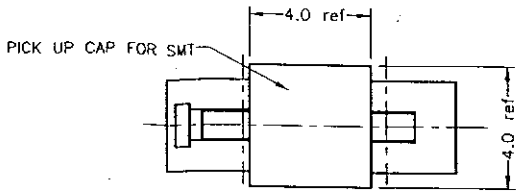
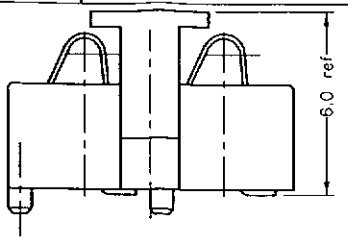
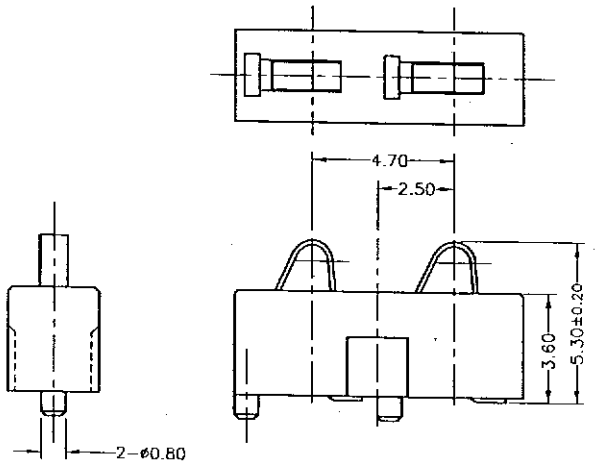
REVISIONS				
SYM	ECN	DESCRIPTION	DATE	APPROVED
B	HK2343	RELEASE TO CUSTOMER.	09/11/02	IP
C	HK2352	ADD AND REMOVE SOME DIMENSION	09/26/02	IP

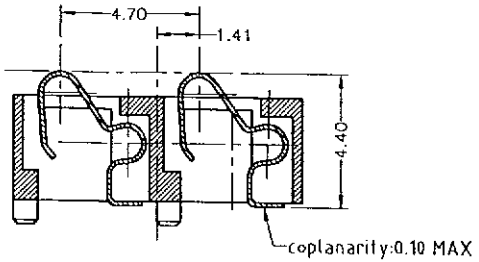


PACKAGE





original position

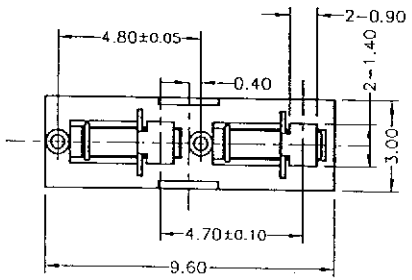


working position

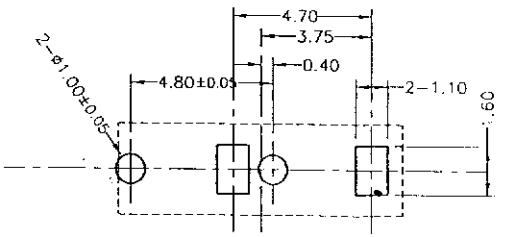
NOTES:

1. MATERIAL:
   A. CONTACT:BERYLLIUM COPPER
   B. INSULATOR: 30% GLASS-FILLED THERMOPLASTIC LCP OR EQUIVALENT UL94V-0, BLACK.
2. FINISH: 15 MICROINCH (0.381 MICRON) GOLD PLATE AT MATING AREA, 100-200 MICROINCH (2.54-5.08 MICRON) AT SOLDER TAIL. 50-100 MICROINCH (1.27-2.54 MICRON) NICKEL UNDERPLATED ALL OVER.
3. NORMAL FORCE AT WORKING POSITION IS:80g MIN.
4. PARTS TO BE PACKAGED IN ANTI-STATIC TAPE AND REEL FOR AUTOMATIC PLACEMENT. ALL PACKAGING MATERIALS TO BE APPROVED BY AMPHENOL ENGINEERING.

AMPHENOL EAST ASIA LIMITED
ENGINEERING DEPARTMENT
DOCUMENT
30 SEP 2002
RECEIVED



CONTROLLED DOCUMENT
30 SEP 2002



RECOMMENDED PCB MOUNTING PATTTERN

CUSTOMER DRAWING

UNLESS OTHERWISE SPECIFIED TOLERANCES U.S. / METRIC: .X +/- 0.20; .XX +/- 0.10; .XXX +/-; FRACTIONS +/-; ANGLES +/- 3°	APPROVAL	DATE	Amphenol — Amphenol East Asia Limited Manufacturing Operation
FOR MATERIALS AND FINISHES SEE NOTES	DRAWN	9/26/02	TITLE: 2 PIN SMT BATTERY CONNECTOR
REMOVE SHARP EDGES	CHECKED		SIZE: A3 — DRAWING NO: C-BC-36S-02 — REV: C
DIMENSIONS: (U.S.) INCHES; (METRIC) (MM)	CHECKED		SCALE: NONE — SHEET 1 OF 1
	DRAWING FILE: PE MASTER\DRAWING\BC\C-BC-36S-02		
	ANGLE OF PROJECTION		